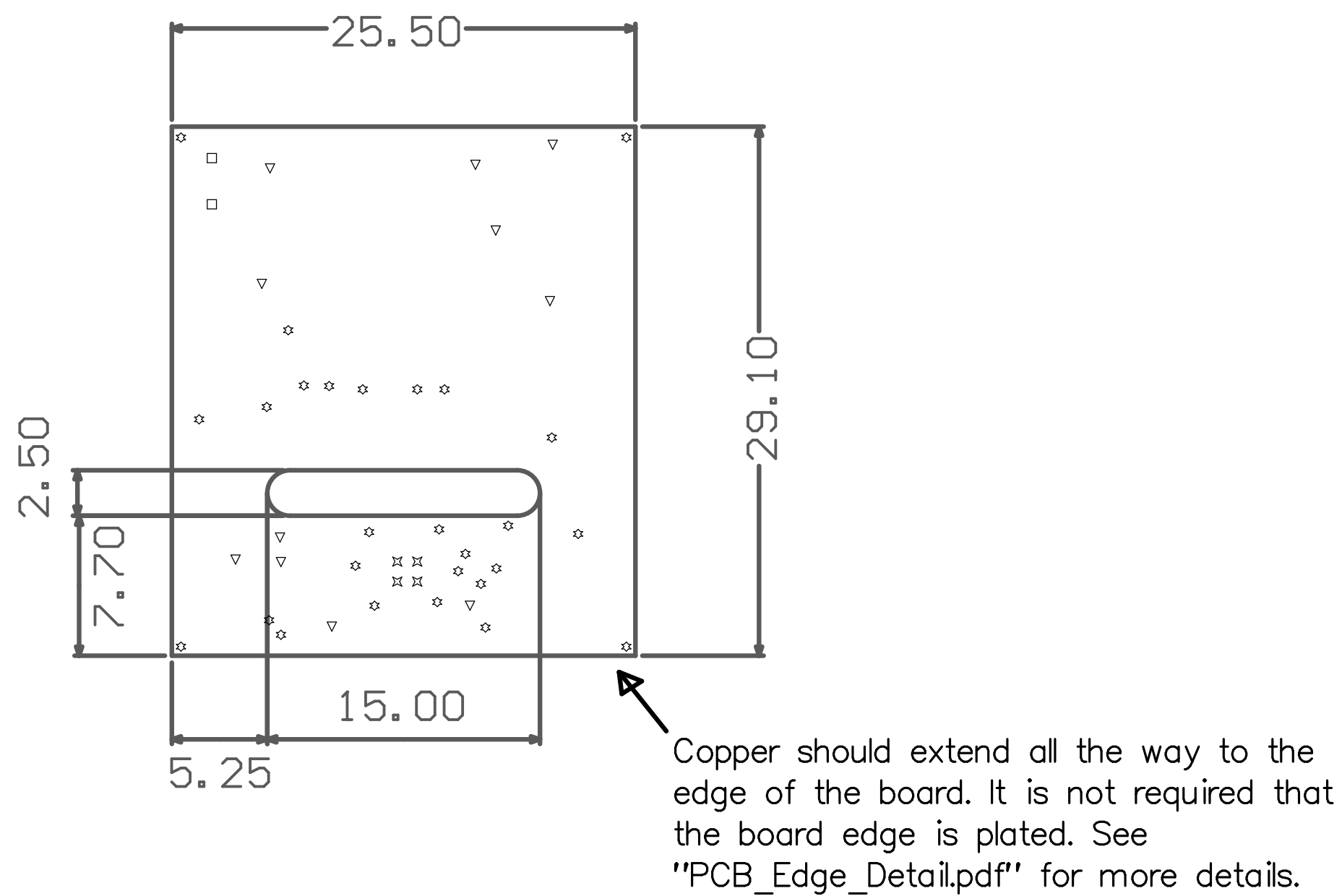



Symbol	Count	Hole Size	Plated	Drill Layer Pair	Pad Shape
⌘	4	0.200mm (7.87mil)	PTH	Top Layer - Bottom Layer	Rounded
☆	27	0.254mm (10.00mil)	PTH	Top Layer - Bottom Layer	Rounded
▽	11	0.508mm (20.00mil)	PTH	Top Layer - Bottom Layer	Rounded
□	2	0.889mm (35.00mil)	PTH	Top Layer - Bottom Layer	Rounded
	44 Total				



LAYERS: 2
MATERIAL: FR4, RoHS, 94v0
THICKNESS: 1.6mm (~62 mils)
FINISH: Gold (ENIG) RoHS
SILK SCREEN: White
SOLDER MASK: GREEN

>> IMPORTANT FABRICATION NOTES <<

- 1) Many pads have intentional undersize solder mask openings/oversize pads for physical strength.
- 2) Make top and bottom solder masks exactly as shown. Do NOT "open-up" the solder mask layers. This design uses "solder-mask-defined-pads".
- 3) Silkscreened Legend (white) must be clean and clear. Silkscreen legend must have good registration. Silkscreen is intentionally placed over bare copper. Do not clip silkscreen to solder mask layer.
- 4) Board must be exactly like: N/A



CrystalFontz
12412 East Saltese Avenue
Spokane Valley, WA 99216 USA
Tel: (509) 892-1200 <http://www.crystalfontz.com>
Copyright © 2019 CrystalFontz America, Inc.

PROJECT

CFA-10107

VERSION

0v1

PCB

PCB10107

REVISION

0v1

DATE

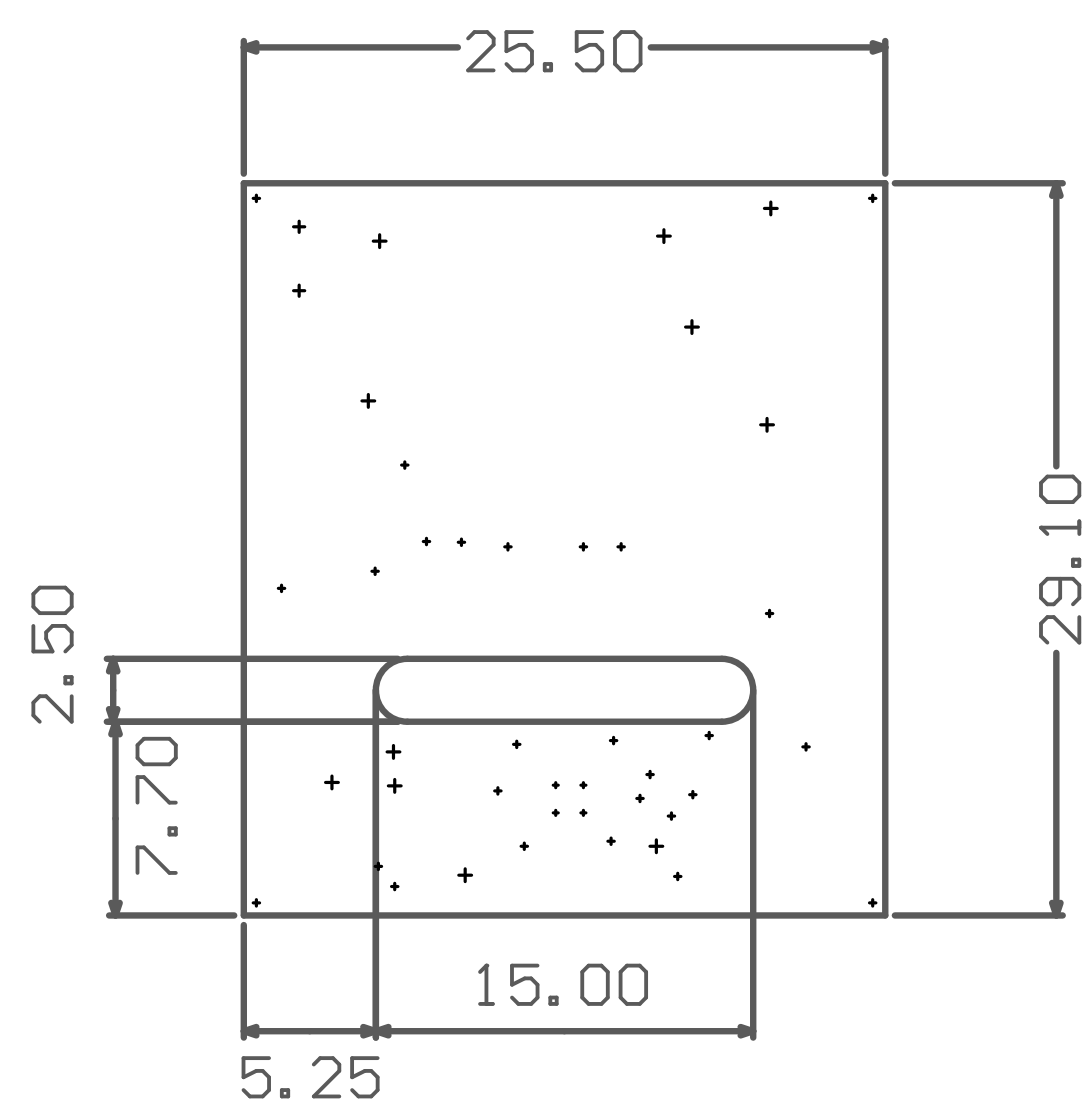
2020-03-03

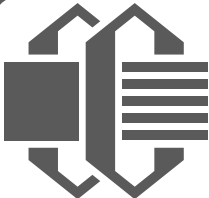
LAYER

Drill Drawing/Notes

FILE NAME

CFA10102_0v1.GD1



 Crystalfontz 12412 East Saltese Avenue Spokane Valley, WA 99216 USA Tel: (509) 892-1200 http://www.crystalfontz.com Copyright © 2019 Crystalfontz America, Inc.	PROJECT CFA-10107		VERSION 0v1
	PCB PCB10107	REVISION 0v1	DATE 2020-03-03
	LAYER Drill Guide		